

Sir:

Transmitted herewith for filing is the Patent Application of:

Inventor: **CHAOYONG LI, DAO HUA ZHANG**

For: **METHOD TO FORM CU SEED LAYER FOR CU INTERCONNECT**

Enclosed are:

- ☒ **5** sheets of drawing(s) - **Informal**
- ☒ An assignment of the invention to **Agency For Science, Technology And Research**
- ☐ An associate power of attorney ☐ Applicant claims small entity status
- ☐ Request & Certification under 35 USC 122(b)(2)(b)(i)

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)	OTHER THAN A SMALL ENTITY	
FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE				\$ 750.
TOTAL CLAIMS	32 -20=	12	x 18 =	\$ 216.
INDEP CLAIMS	2 -3=	0	x 84 =	\$ 0.
SUB TOTAL				\$ 966.
ASSIGNMENT				\$40.
TOTAL				\$ 1,006.

- ☒ Please charge my Deposit Account No. 19-0033 in the amount of **\$ 1,006**. A duplicate copy of this sheet is enclosed.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.
- ☒ Any additional filing fees required under 37 CFR §1.16.
- ☒ Any patent application processing fees under 37 CFR §1.17.

Respectfully submitted,
George O. Saile
GEORGE O. SAILE, REG. NO. 19,572

EXPRESS MAIL CERTIFICATE

Express Mail No. **EV 313926935 US**

I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Alexandria, VA, 22313-1450. Applicant and/or Attorney requests the date of deposit as the Filing Date.

8 August 2003

Date of deposit

George O. Saile Aug 8, 2003
Signature / Date

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